

Applications Note:SY7104

High Efficiency 6V, 4A, 1MHz Step Up Regulator

General Description

SY7104 is a high efficiency, current-mode control Boost DC to DC regulator with an integrated $90m\Omega$ $R_{DS(ON)}$ N-channel MOSFET. The fixed 1MHz switching frequency and internal compensation reduce external component count and save the PCB space. The build-in internal soft start circuitry minimizes the inrush current at start-up.

L Temperature Code

Package type

DFN3×3-10

Note

4A

Package Code **Optional Spec Code**

Ordering Information

Temperature Range: -40°C to 85°C

SY7104 [[]]

Ordering Number

SY7104DBC

Features

- Wide input range: 2-6V •
- 1MHz switching frequency •
- Minimum on time: 100ns typical •
- ie i Minimum off time: 100ns typical •
- Max output voltage: 6V •
- Internal 4A switch
- Internal soft start
- Over temperature protection
- Over current protection
- Low $R_{DS(0N)}$: 90m Ω typical
- RoHS Compliant and Halogen Free
- Compact package: DFN3x 3-10

Applications

- 1-cell Li-ion Battery powered applications
- Portable devices







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Pinout (top view)



(DFN3×3-10)

Top Mark: ELxyz (Device code: EL , x=year code, y=week code, z= lot number code)

Pin Name	Pin Number	Pin Description
NC	1,3,6, 8,10	No connection.
GND	11	Ground pin.
LX	4,5	Phase node. Connect an inductor across the power input and this pin.
FB	2	Feedback pin. Connect a resistor R1 between V_{OUT} and FB, and a resistor R2 across FB and GND to program the output voltage: $V_{OUT}=0.6V \times (R1/R2+1)$
EN	9	Enable control. Pull high to turn on Do not leave it floating.
VDD	7	IC power supply input

Absolute Maximum Ratings (Note 1)

All other pins0.3V to 7V
Power Dissipation, PD @ $T_A = 25^{\circ}C$ DFN $3 \times 3-10$,
Package Thermal Resistance (Note 2)
θ _{JA} 38°C/W
θ JC 8°C/W
Junction Temperature Range40 to 150°C
Lead Temperature (Soldering, 10 second secon
Storage Temperature Range
Dynamic LX voltage in 50ns duration VIN+3V

Recommended Operating Conditions (Note 3)

FB pin	0.3V to 3.6V
VDD pin	2V to 6V
All other pins	0V to 6V
Junction Temperature Range	40°C to 125°C
Ambient Temperature Range	
CINT	



SY7104

Block Diagram





Electrical Characteristics

(V_{IN} = 3V, V_{OUT} = 5V, I_{OUT} = 1A, TA = 25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Voltage Range	V _{IN}		2		6	V
Quiescent Current	Iq	V _{FB} =0.66V		100		μA
Shutdown Current	I _{SHDN}	EN=0			10	μA
Low Side Main FET R _{ON}	R _{DS(ON)}			90		mΩ
Main FET Current Limit	I _{LIM}		4			A
Switching Frequency	F _{SW}			1		MHz
Feedback Reference Voltage	V _{REF}		0.588	0.6	0.612	V
VDD UVLO Rising Threshold	V _{IN_UVLO}			l	1.9	V
UVLO Hysteresis	V _{UVLO_HYS}			0.1		V
Thermal Shutdown Temperature	T _{SD}			150	•	°C
EN Rising Threshold	V _{ENH}		1.5			V
EN Falling Threshold	V _{ENL}		4		0.4	V
EN Pin Input Current	I _{EN}		0		100	nA

Note 1: Stresses beyond the "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: θ JA is measured in the natural convection at TA = 25 °C on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard. Test condition: Device mounted on 2" x 2" FR-4 substrate PCB, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane.

Note 3: The device is not guaranteed to function outside its operating conditions





Typical Performance Characteristics



SY7104



SY7104



Applications Information

Because of the high integration in SY7104, the application circuit based on this regulator IC is rather simple. Only input capacitor C_{IN} , output capacitor C_{OUT} , inductor L and feedback resistors (R_1 and R_2) need to be selected for the targeted applications.

Feedback resistor divider R1 and R2

Choose R_1 and R_2 to program the proper output voltage. To minimize the power consumption under light load, it is desirable to choose large resistance values for both R_1 and R_2 . A value between 10k and 1M is recommended for both resistors. If R_1 =200k is chosen, then R_2 can be calculated to be:



Input capacitor CIN

The ripple current through input capacitor is calculated as:

$$I_{CIN_RMS} = \frac{V_{IN} \cdot (V_{OUT} - V_{IN})}{2\sqrt{3} \cdot L \cdot F_{SW} \cdot V_{OUT}} (A)$$

To minimize the potential noise problem, place a typical X5R or better grade ceramic capacitor really close to the VDD and GND pins. Care should be taken to minimize the loop area formed by C_{IN} , and VDD/GND pins. In this case a 22uF low ESR ceramic capacitor is recommended.

Output capacitor Cour

The output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken into account when selecting this capacitor. For the best performance, it is recommended to use X5R or better grade ceramic capacitor with 10V rating and more than two 22uF capacitors.

Boost inductor L

There are several considerations in choosing this inductor.

 Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum average input current. The inductance is calculated as:

$$L = \left(\frac{V_{IN}}{V_{OUT}}\right)^2 \frac{(V_{OUT} - V_{IN})}{F_{SW} \times I_{OUT_MAX} \times 40\%} (H)$$

where F_{SW} is the switching frequency and Lourman is the maximum load current.

SY7104 regulator IC is less sensitive to the ripple current variations. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

 The saturation current rating of an inductor must be selected to guarantee an adequate margin to the peak inductor current under full load conditions.

$$I_{\text{SAT_MIN}} \left(\frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times I_{\text{OUT_MAX}} + \left(\frac{V_{\text{IN}}}{V_{\text{OUT}}}\right)^2 \frac{(V_{\text{OUT}} - V_{\text{IN}})}{2 \times F_{\text{SW}} \times L}$$

The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with DCR<10m Ω to achieve a good overall efficiency.

Enable Operation

. V

Pulling the EN pin low (<0.4V) will shut down the device. During the shut down mode, the SY7104 shut down current drops to lower than 10 μ A. Driving the EN pin high (>1.5V) will turn on the IC again.

Rectifier Diode Selection

Schottky diode is a good choice for high efficiency operation because of its low forward voltage drop and fast reverse recovery. The maximum current rating of the diode must be higher than maximum input current. And the average current rating of the diode must be higher than the output current.



Layout Design

The layout design of SY7104 regulator is highly simplified. To achieve a higher efficiency and better noise immunity, following components should be placed close to the IC: C_{IN}, L, R₁ and R₂.

1) It is desirable to maximize the PCB copper area connecting to GND pin to achieve a better thermal performance and noise immunity. If the board space allowed, a designated ground plane layer is highly recommended.

2) C_{IN} must be close to VDD and GND pins. The loop area formed by C_{OUT}, LX and GND pins must be minimized.

3) The PCB copper area associated with LX pin must be minimized to improve the noise immunity.

4) The components R_1 and R_2 , and the trace connecting to the FB pin must NOT be adjacent to the LX node on the PCB layout to minimize the noise coupling to FB pin.

5) If the system chip interfacing with the EN pin has a sin Ity to a desirable t a EN and G a ely turning on the a ely turning o high impedance state at shutdown mode and the VDD pin is connected directly to a power source such as a Li-Ion battery, it is desirable to add a pull down $1M\Omega$ resistor across the EN and GND pins to prevent the noise from falsely turning on the regulator at shutdown













Taping & Reel Specification

1. DFN3x3-10 taping orientation



Package	Tape width	Pocket	Reel size	Reel	Trailer	Leader length	Qty per
types	(mm)	pitch(mm)	(Inch)	width(mm)	length(mm)	(mm)	reel
DFN3x3	10	8	13"	12.4	400	400	5000

3. Others: NA